

# **HVL147**

# Silicon Epitaxial Trench Pin Diode for Antenna Switching

REJ03G0393-0200 Rev.2.00 Oct 20, 2004

### **Features**

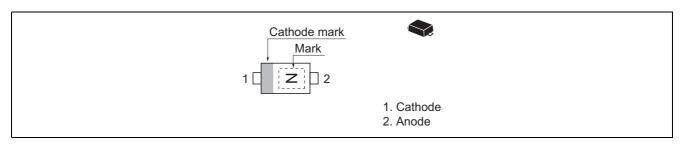
- Adopting the trench structure improves low capacitance. (C = 0.31 pF max)
- Low forward resistance. (rf =  $1.5 \Omega \text{ max}$ )
- Low operation current.
- Extremely small Flat Package (EFP) is suitable for surface mount design.

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### **Ordering Information**

Type No.	Laser Mark	Package Code
HVL147	N	EFP

## **Pin Arrangement**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Symbol Value	
Reverse voltage	V <sub>R</sub>	30	V
Forward current	current I <sub>F</sub> 100		mA
Power dissipation	Pd	100	mW
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

### **Electrical Characteristics**

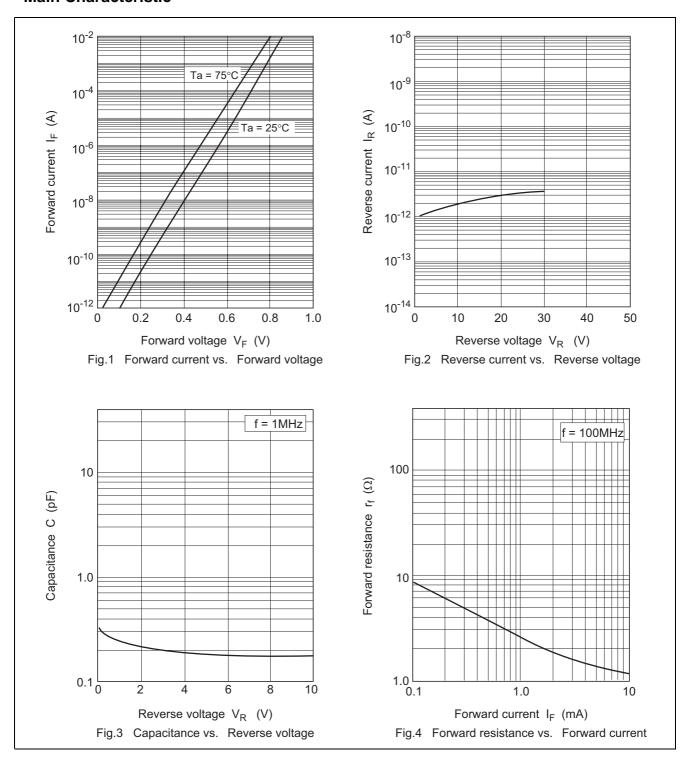
 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I <sub>R</sub>	_	_	100	nA	V <sub>R</sub> = 30 V
Forward voltage	V <sub>F</sub>	_	_	1.00	V	I <sub>F</sub> = 10 mA
Capacitance	С	_	_	0.31	pF	$V_R = 1 V$ , $f = 1 MHz$
Forward resistance	r <sub>f</sub>	_	2.5	_	Ω	I <sub>F</sub> = 2 mA, f = 100 MHz
		_	_	1.5		I <sub>F</sub> = 10 mA, f = 100 MHz
ESD-Capability *1	_	100	_	_	V	$C = 200 \text{ pF}, R = 0 \Omega$ , Both forward and reverse direction 1 pulse.

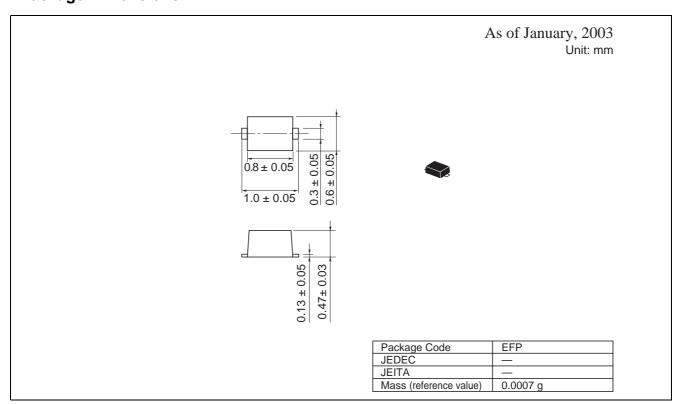
Notes: 1. Failure criterion;  $I_R > 100 \text{ nA}$  at  $V_R = 30 \text{ V}$ 

- 2. Please do not use the soldering iron due to avoid high stress to the EFP package.
- 3. The material of lead is exposed for cutting plane. There for, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

### **Main Characteristic**



## **Package Dimensions**



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